Special Issue

Applications of Deep Learning and Artificial Intelligence Methods

Message from the Guest Editors

Deep Learning and Artificial Intelligence have attracted great attention in almost every field in recent years. Applications of deep learning and artificial intelligence methods is now pervasive into many various fields beyond the conventional computer engineering areas. Therefore, the goal of this special issue is intended for discussing new ideas and recent experimental results in the field of applications of deep learning and artificial intelligence methods. Topics of interest include, but are not limited to, the following: -Artificial Intelligence Tools & Applications -Automatic Control -Natural Language Processing -Computer Vision and Speech Understanding -Data Mining and Analysis -Heuristic and AI Planning Strategies -Intelligent System -Robotics

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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